



嵌合断面図 (参考)
MATED DRAWING (REF.)

注記 NOTES:

1. 使用材料 MATERIAL
 ウェハー: 液晶ポリマー ガラス充填 ,UL94V-0(黒)
 WAFER :LIQUID CRYSTAL POLYMER
 (GLASS FILLED), UL94V-0 (COLOR:BLACK)
 ピン :黄銅 (t=0.15)
 PIN :BRASS(t=0.15)
2. メッキ仕様 PLATING
 金メッキ 0.25 MICROMETER MINIMUM (コンタクト部)
 GOLD 0.25 MICROMETER MINIMUM (CONTACT AREA).
 金メッキ 0.4 MICROMETER MAXIMUM (テール部)
 GOLD 0.4 MICROMETER MAXIMUM (TAIL AREA).
 下地メッキ: ニッケルメッキ 1.5 MICROMETER MINIMUM
 UNDER PLATING : NICKEL 1.5 MICROMETER MINIMUM.
3. (全極数/2) = 偶数の場合に適用。
 APPLY FOR (CIRCUIT/2)=EVEN.
4. 嵌合相手: 54722 シリーズ, 54037 シリーズ
 MATE WITH : 54722 SERIES, 54037 SERIES.
5. テール平坦度は、0.1 MAXIMUM
 TAIL COPLANARITY TO BE 0.1 MAXIMUM.

有効嵌合長
MATING
LENGTH

REVISED EC NO: J2012-0135 DRWN: YON002 2011/07/01 CHKD: TASAKAWA 2011/07/01 APPR: MSASAO 2011/07/29	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER	± 0.20	DRAWN BY SAIHARA	DATE 2000/10/05	TITLE 0.5 B-T-O-B CONN PLUG ASSY (HGT=1.5)			
	10 OVER 30 UNDER	± 0.25	CHECKED BY MSASAO	DATE 2003/03/31	APPROVED BY MSASAO 2003/03/31			
	30 OVER	± 0.30	MATERIAL NO. SEE SHEET 1		DOCUMENT NO. SD-55560-006		SHEET NO. 2 OF 2	
	ANGULAR ±3 °		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS								